



9NM65-S

Power MOSFET

9.0A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

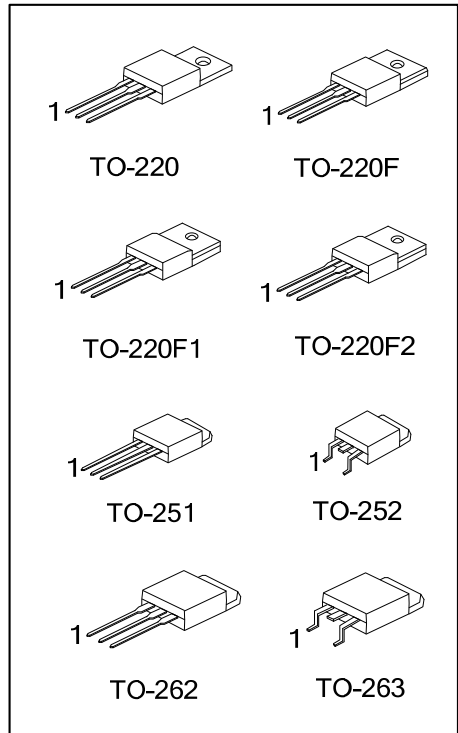
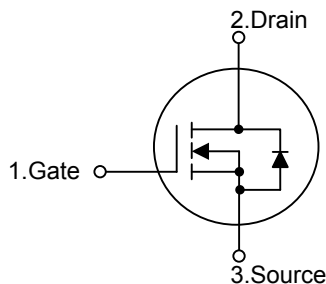
DESCRIPTION

The **UTC 9NM65-S** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} < 0.64\Omega$ @ $V_{GS}=10V$, $I_D=4.5A$
- * High switching Speed
- * 100% avalanche tested
- * Improved dv/dt capability

SYMBOL



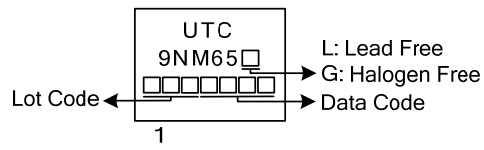
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
9NM65L-TA3-T	9NM65G-TA3-T	TO-220	G	D	S	Tube
9NM65L-TF1-T	9NM65G-TF1-T	TO-220F1	G	D	S	Tube
9NM65L-TF2-T	9NM65G-TF2-T	TO-220F2	G	D	S	Tube
9NM65L-TF3-T	9NM65G-TF3-T	TO-220F	G	D	S	Tube
9NM65L-TM3-T	9NM65G-TM3-T	TO-251	G	D	S	Tube
9NM65L-TN3-R	9NM65G-TN3-R	TO-252	G	D	S	Tape Reel
9NM65L-T2Q-T	9NM65G-T2Q-T	TO-262	G	D	S	Tube
9NM65L-TQ2-T	9NM65G-TQ2-T	TO-263	G	D	S	Tube
9NM65L-TQ2-R	9NM65G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

9NM65G-TA3-T (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2 TF3: TO-220F, TM3: TO-251, TN3: TO-252 T2Q: TO-262, TQ2: TO-263 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I_D	9	A
	Pulsed (Note 2)	I_{DM}	36	A
Avalanche Current		I_{AR}	2.2	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	380	mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	5.5	V/ns
Power Dissipation	TO-220/TO-262 TO-263	P_D	150	W
	TO-220F/TO-220F1		44	W
	TO-220F2		49	W
	TO-251/TO-252		62	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55~+150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=157\text{mH}$, $I_{AS}=2.2\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^{\circ}\text{C}$

4. $I_{SD} \leq 9\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-262/TO-263	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220/TO-262 TO-263	θ_{JC}	0.83	$^{\circ}\text{C}/\text{W}$
	TO-220F/TO-220F1		2.84	$^{\circ}\text{C}/\text{W}$
	TO-220F2		2.55	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-252		2.0	$^{\circ}\text{C}/\text{W}$

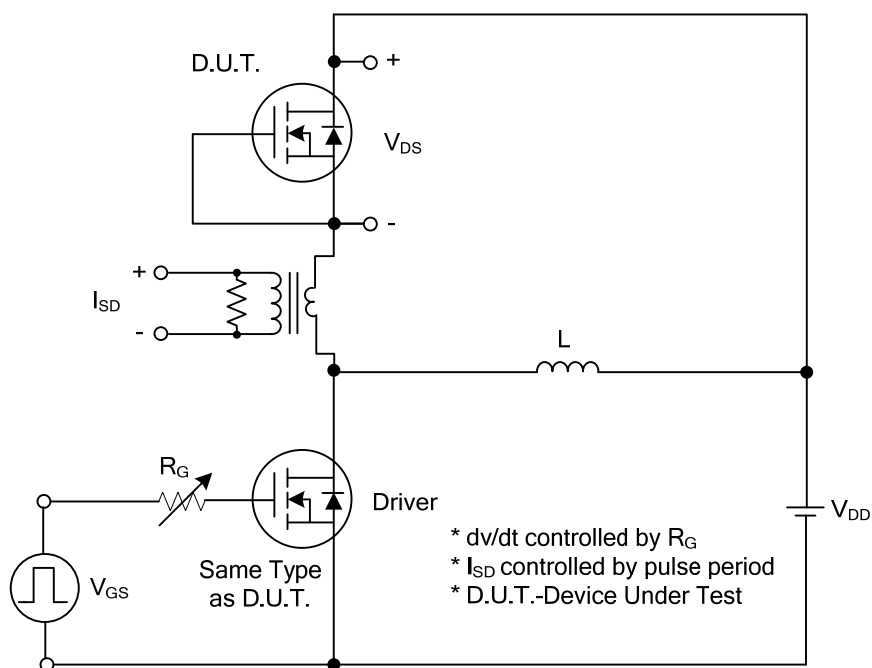
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V, T _J =25°C			10	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V			+100	nA
	Reverse		V _{GS} =-30V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =4.5A			0.64	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		510		pF
Output Capacitance		C _{OSS}			350		pF
Reverse Transfer Capacitance		C _{RSS}			26		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 2)		Q _G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A , I _G =100μA (Note 1, 2)		39		nC
Gate to Source Charge		Q _{GS}			5		nC
Gate to Drain Charge		Q _{GD}			14		nC
Turn-ON Delay Time (Note 2)		t _{D(ON)}	V _{DD} =30V, V _{GS} =10V, I _D =0.5A, R _G =25Ω (Note 1, 2)		50		ns
Rise Time		t _R			47		ns
Turn-OFF Delay Time		t _{D(OFF)}			185		ns
Fall-Time		t _F			60		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				9	A
Maximum Body-Diode Pulsed Current (Note 1)		I _{SM}				36	A
Drain-Source Diode Forward Voltage (Note 2)		V _{SD}	I _S =9.0A, V _{GS} =0V			1.4	V
Reverse Recovery Time		t _{rr}	I _S =9.0A, V _{GS} =0V,		320		ns
Reverse Recovery Charge (Note 1)		Q _{rr}	dI _F /dt=100 A/μs		3.9		μC

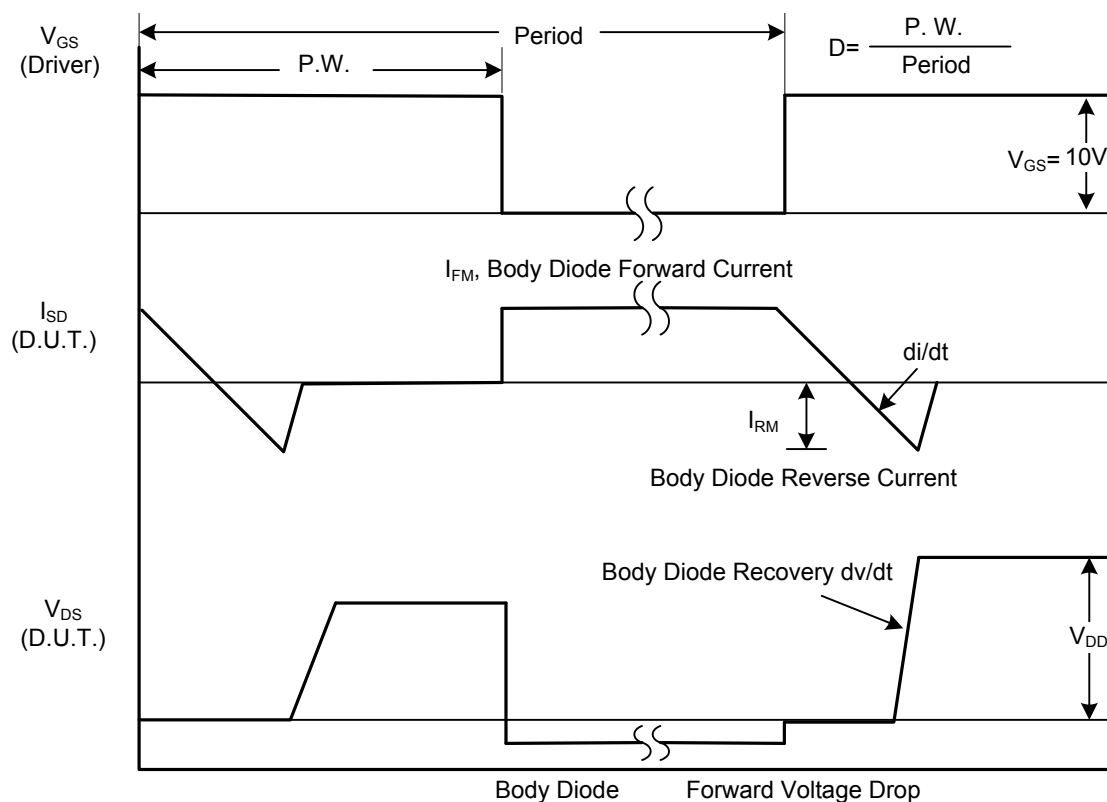
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

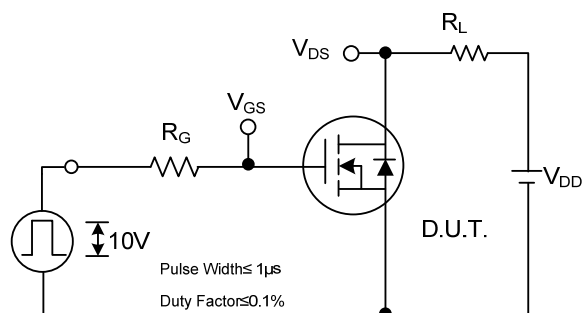


Peak Diode Recovery dv/dt Test Circuit

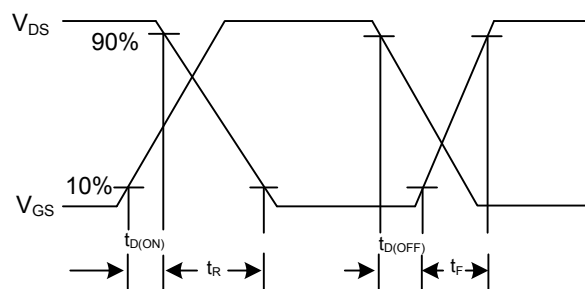


Peak Diode Recovery dv/dt Waveforms

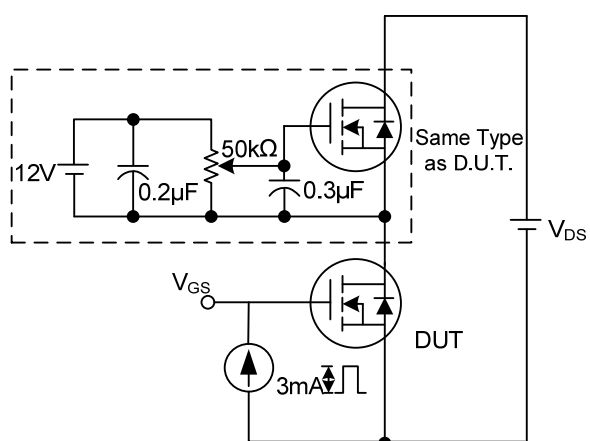
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



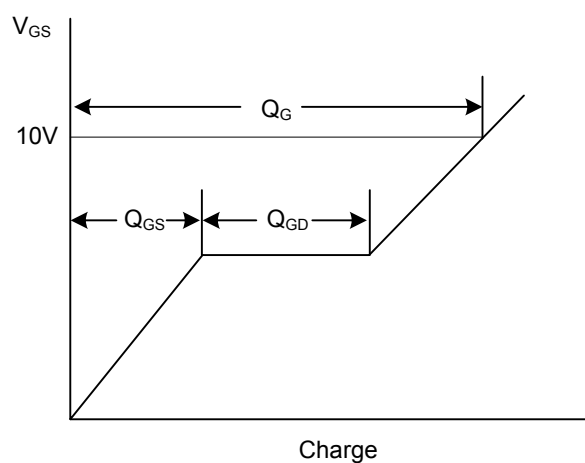
Switching Test Circuit



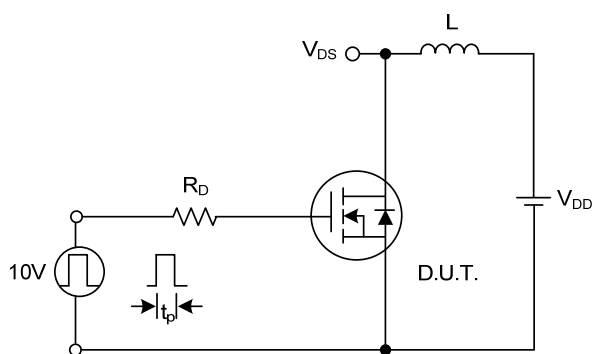
Switching Waveforms



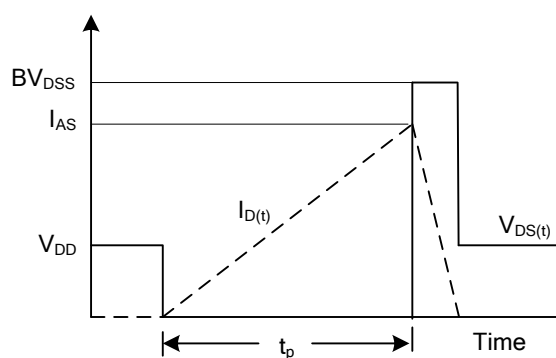
Gate Charge Test Circuit



Gate Charge Waveform

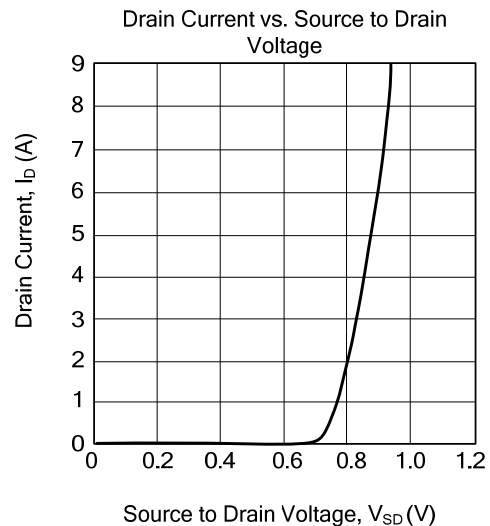
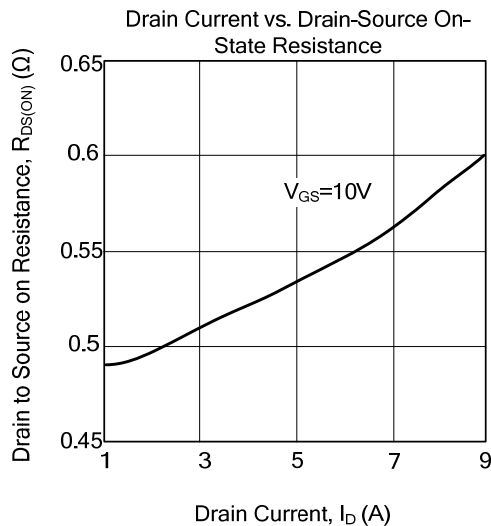
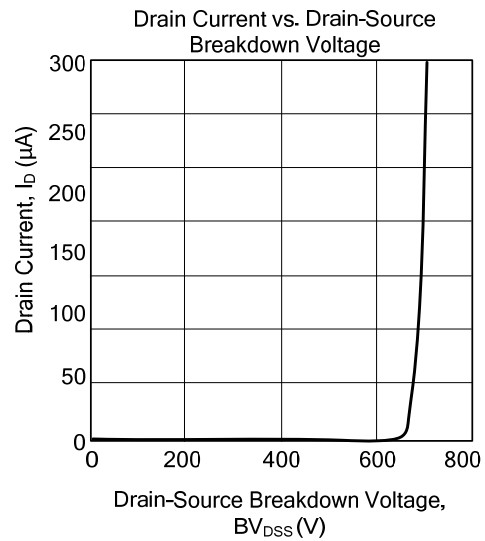
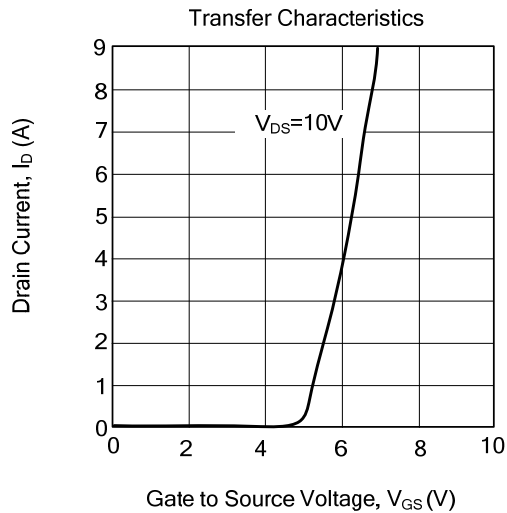


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS



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